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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| In re Application of: |) Examiner: R. Zacharia # (2) |
|--|-------------------------------|
| DAISHI SAIKI ET AL. | Group Art Unit: 1773 |
| Application No.: 09/897,014 |) 3.79.03 |
| Filed: July 3, 2001 | |
| For: MULTILAYERED STRUCTURE RESIN MOLDED PRODUCT AND METHOD OF MANUFACTURING MULTILAYERED STRUCTURE RESIN MOLDED PRODUCT |) :) :) : March 18, 2003 |

Commissioner for Patents Washington, D.C. 20231

THIRD INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the duty of disclosure under 37 C.F.R. § 1.56 and in accordance with the practice under 37 C.F.R. §§ 1.97 and 1.98, the Examiner's attention is directed to the documents listed on the enclosed Form PTO-1449. Copies of the listed documents are also enclosed.

The concise explanation of relevance for the non-English document may be found, inter alia, in the enclosed English abstract and/or in the enclosed corresponding U.S. Patent No. 5,645,786.

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CONCLUSION

It is respectfully requested that the above information be considered by the Examiner and that a copy of the enclosed Form PTO-1449 be returned indicating that such information has been considered.

We also enclose a check for the required fee of \$180.00 to cover the Information Disclosure Statement under 37 C.F.R. § 1.97(c)(2).

Applicants' undersigned attorney may be reached in our New York office by telephone at (212) 218-2100. All correspondence should continue to be directed to our address given below.

Respectfully submitted,

ttorney for Applicants

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